

RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:3.0AMP

Contact Resistance:20m Ω Max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000M Ω Min

Operation Temperature:-40 $^{\circ}$ c to +105 $^{\circ}$ c

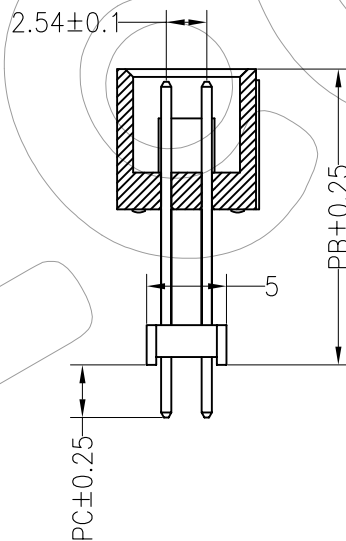
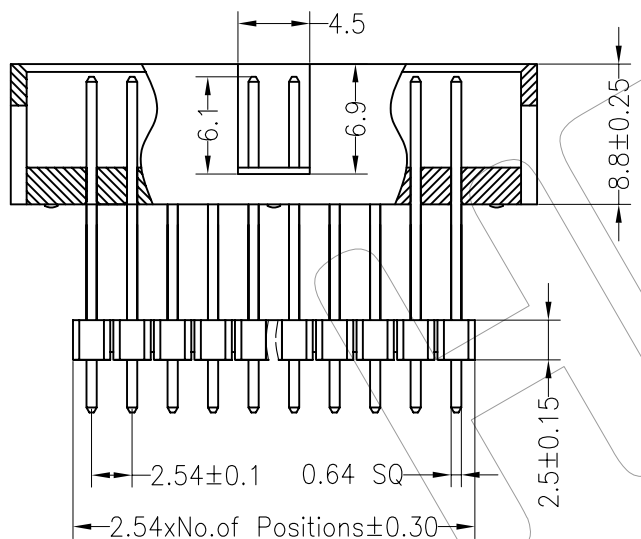
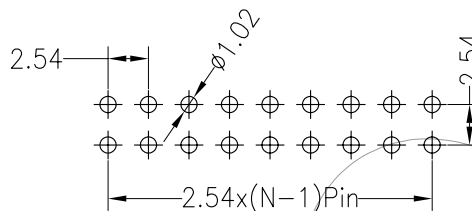
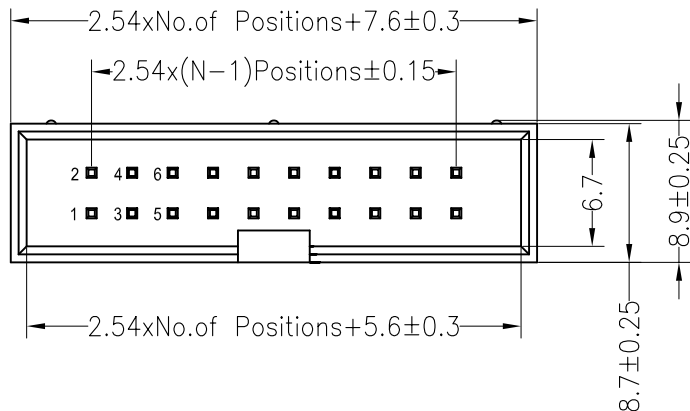
Contact Material:Brass

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 230 $^{\circ}$ C for 30-60 seconds
(260 $^{\circ}$ C for 5 seconds)



Ordering Information

HC-BH410 XX S XX X B D00 X 01

No.of Pins
6--64

Contact Plating
G0:Gold Flash
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Insulator Material
Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
F=BK-LCP

Packing
T=Tube
A=Tray
P=Tube+Cap

Dimension antitheses list		
ITEM	PC	PB
Standard	3.30	
Alternate		

OPERATION

X.X ± 0.30

X.XX ± 0.20

X.XXX ± 0.10

Angle $\pm 3^{\circ}$

DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

Φ

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-BH410XXSXXXBD00X01

TITLE:

2.54mm H8.8+Pin Header Straight Npin
Box Header

Dimension antitheses list		
ITEM	PC	PB
Standard	3.30	
Alternate		

				OPERATION		DRAW		SCALE	
				X.X ± 0.30		Ayang		FIT	
				X.XX ± 0.20				UNIT	
				X.XXX ± 0.10				SIZE	
				Angle $\pm 3^{\circ}$				A4	
				DIM TOL				SHEET	
								1/1	
								PROJ.	
								Φ	
A0		NEW DRAWING						PART NO.	
REV		DATE		MODIFICATION DESCRIPTION		CHANGE		TITLE:	
1		2		3		4		7	
								8	
								9	